

	1	2	3	4	5	6	7	8	9		
G	RoHS										
F				Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)			SPECIFICATIONS Rated Current:1.5AMP Contact Resistance:20mΩ Max Withstand Voltage:500V AC/DC Insulation Resistance:1000MΩ Min Operation Temperature:-40°c to +105°c				
E							Contact Material:Brass Contact Plating:Au or Sn Over Ni Insulator Material:Polyester(UL94V-0) Standard: PA6T Max.Processing Temp: 230°C for 30-60 seconds (260°C for 10 seconds)				
D							Ordering Information HC-FH540 02 XX X X XX M U X 01 No.of Pins Per Row 2*40 Insulator Material Option A=BK-PBT B=BK-PA66 C=BK-PA6T D=BK-PA46 E=BK-PA9T F=BK-LCP Post W=With Post N=W/O Post Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin Packing T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar				
C											
B											
A											
				OPERATION		DRAW	Ayang	SCALE	FIT	HECON 东莞市禾康电子有限公司 DONGGUAN HECON ELECTRONICS CO.,LTD	
				X.X	±0.30						
				X.XX ±0.20		CHECK		UNIT	mm	PART NO. HC - FH54002XXXXXXXXMUX01	
				X.XXX ±0.10							
				Angle ±3'		APPROVE		SIZE	A4	TITLE: 2.0mm H4.0 Dual Row SMT Female Header	
				DIM TOL							
REV	DATE	MODIFICATION DESCRIPTION		CHANGE					PROJ.		
1		2	3	4	5	6	7	8	9		